

|                     |       |
|---------------------|-------|
| $V_{DSS}$           | 1200V |
| $R_{DS(on)}$ (Typ.) | 160mΩ |
| $I_D$               | 22A   |
| $P_D$               | 165W  |

#### ●Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

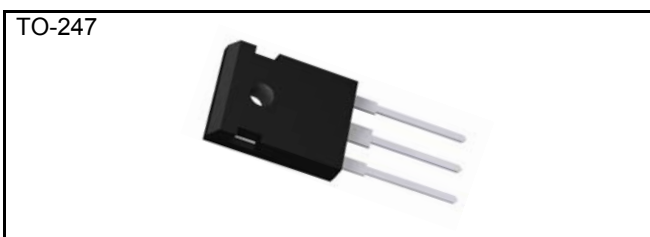
#### ●Application

- Solar inverters
- DC/DC converters
- Switch mode power supplies
- Induction heating
- Motor drives

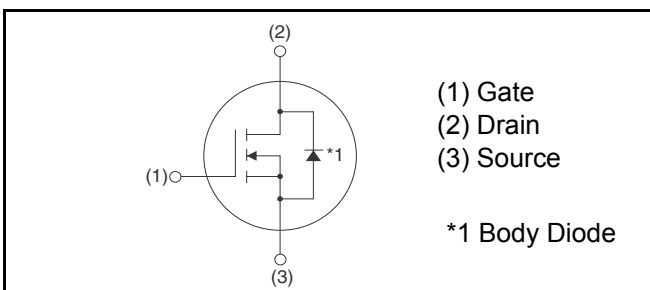
#### ●Absolute maximum ratings ( $T_a = 25^\circ\text{C}$ )

| Parameter                                      |                           | Symbol             | Value       | Unit             |
|------------------------------------------------|---------------------------|--------------------|-------------|------------------|
| Drain - Source voltage                         |                           | $V_{DSS}$          | 1200        | V                |
| Continuous drain current                       | $T_c = 25^\circ\text{C}$  | $I_D^{*1}$         | 22          | A                |
|                                                | $T_c = 100^\circ\text{C}$ | $I_D^{*1}$         | 16          | A                |
| Pulsed drain current                           |                           | $I_{D,pulse}^{*2}$ | 55          | A                |
| Gate - Source voltage                          |                           | $V_{GSS}$          | -6 to 22    | V                |
| Power dissipation ( $T_c = 25^\circ\text{C}$ ) |                           | $P_D$              | 165         | W                |
| Junction temperature                           |                           | $T_j$              | 175         | $^\circ\text{C}$ |
| Range of storage temperature                   |                           | $T_{stg}$          | -55 to +175 | $^\circ\text{C}$ |

#### ●Outline



#### ●Inner circuit



#### ●Packaging specifications

|      |                           |           |
|------|---------------------------|-----------|
| Type | Packing                   | Tube      |
|      | Reel size (mm)            | -         |
|      | Tape width (mm)           | -         |
|      | Basic ordering unit (pcs) | 30        |
|      | Taping code               | -         |
|      | Marking                   | SCT2160KE |

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## ●Thermal resistance

| Parameter                                    | Symbol     | Values |      |      | Unit |
|----------------------------------------------|------------|--------|------|------|------|
|                                              |            | Min.   | Typ. | Max. |      |
| Thermal resistance, junction - case          | $R_{thJC}$ | -      | 0.70 | 0.91 | °C/W |
| Thermal resistance, junction - ambient       | $R_{thJA}$ | -      | -    | 50   | °C/W |
| Soldering temperature, wavesoldering for 10s | $T_{sold}$ | -      | -    | 265  | °C   |

●Electrical characteristics ( $T_a = 25^\circ\text{C}$ )

| Parameter                                   | Symbol            | Conditions                                                | Values |      |      | Unit          |
|---------------------------------------------|-------------------|-----------------------------------------------------------|--------|------|------|---------------|
|                                             |                   |                                                           | Min.   | Typ. | Max. |               |
| Drain - Source breakdown voltage            | $V_{(BR)DSS}$     | $V_{GS} = 0V, I_D = 1mA$                                  | 1200   | -    | -    | V             |
| Zero gate voltage drain current             | $I_{DSS}$         | $V_{DS} = 1200V, V_{GS} = 0V$<br>$T_j = 25^\circ\text{C}$ | -      | 1    | 10   | $\mu\text{A}$ |
|                                             |                   | $T_j = 150^\circ\text{C}$                                 | -      | 2    | -    |               |
| Gate - Source leakage current               | $I_{GSS+}$        | $V_{GS} = +22V, V_{DS} = 0V$                              | -      | -    | 100  | nA            |
| Gate - Source leakage current               | $I_{GSS-}$        | $V_{GS} = -6V, V_{DS} = 0V$                               | -      | -    | -100 | nA            |
| Gate threshold voltage                      | $V_{GS(th)}$      | $V_{DS} = V_{GS}, I_D = 2.5mA$                            | 1.6    | -    | 4.0  | V             |
| Static drain - source on - state resistance | $R_{DS(on)}^{*3}$ | $V_{GS} = 18V, I_D = 7A$<br>$T_j = 25^\circ\text{C}$      | -      | 160  | 208  | $m\Omega$     |
|                                             |                   | $T_j = 125^\circ\text{C}$                                 | -      | 226  | -    |               |
| Gate input resistance                       | $R_G$             | $f = 1MHz, \text{open drain}$                             | -      | 13.7 | -    | $\Omega$      |

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●Electrical characteristics ( $T_a = 25^\circ\text{C}$ )

| Parameter                                    | Symbol            | Conditions                                                                                                        | Values |      |      | Unit          |
|----------------------------------------------|-------------------|-------------------------------------------------------------------------------------------------------------------|--------|------|------|---------------|
|                                              |                   |                                                                                                                   | Min.   | Typ. | Max. |               |
| Transconductance                             | $g_{fs}^{*3}$     | $V_{DS} = 10\text{V}, I_D = 7\text{A}$                                                                            | -      | 2.4  | -    | S             |
| Input capacitance                            | $C_{iss}$         | $V_{GS} = 0\text{V}$                                                                                              | -      | 1200 | -    | pF            |
| Output capacitance                           | $C_{oss}$         | $V_{DS} = 800\text{V}$                                                                                            | -      | 45   | -    |               |
| Reverse transfer capacitance                 | $C_{rss}$         | $f = 1\text{MHz}$                                                                                                 | -      | 7    | -    |               |
| Effective output capacitance, energy related | $C_{o(er)}$       | $V_{GS} = 0\text{V}$<br>$V_{DS} = 0\text{V to } 500\text{V}$                                                      | -      | 71   | -    | pF            |
| Turn - on delay time                         | $t_{d(on)}^{*3}$  | $V_{DD} = 400\text{V}, I_D = 7\text{A}$                                                                           | -      | 23   | -    | ns            |
| Rise time                                    | $t_r^{*3}$        | $V_{GS} = 18\text{V}/0\text{V}$                                                                                   | -      | 25   | -    |               |
| Turn - off delay time                        | $t_{d(off)}^{*3}$ | $R_L = 57\Omega$                                                                                                  | -      | 67   | -    |               |
| Fall time                                    | $t_f^{*3}$        | $R_G = 0\Omega$                                                                                                   | -      | 27   | -    |               |
| Turn - on switching loss                     | $E_{on}^{*3}$     | $V_{DD} = 600\text{V}, I_D = 7\text{A}$<br>$V_{GS} = 18\text{V}/0\text{V}$<br>$R_G = 0\Omega, L = 500\mu\text{H}$ | -      | 126  | -    | $\mu\text{J}$ |
| Turn - off switching loss                    | $E_{off}^{*3}$    | * $E_{on}$ includes diode reverse recovery                                                                        | -      | 55   | -    |               |

●Gate Charge characteristics ( $T_a = 25^\circ\text{C}$ )

| Parameter            | Symbol          | Conditions                              | Values |      |      | Unit |
|----------------------|-----------------|-----------------------------------------|--------|------|------|------|
|                      |                 |                                         | Min.   | Typ. | Max. |      |
| Total gate charge    | $Q_g^{*3}$      | $V_{DD} = 400\text{V}$                  | -      | 62   | -    | nC   |
| Gate - Source charge | $Q_{gs}^{*3}$   | $I_D = 7\text{A}$                       | -      | 14   | -    |      |
| Gate - Drain charge  | $Q_{gd}^{*3}$   | $V_{GS} = 18\text{V}$                   | -      | 20   | -    |      |
| Gate plateau voltage | $V_{(plateau)}$ | $V_{DD} = 400\text{V}, I_D = 7\text{A}$ | -      | 9.6  | -    | V    |

\*1 Limited only by maximum temperature allowed.

\*2  $PW \leq 10\mu\text{s}$ , Duty cycle  $\leq 1\%$ 

\*3 Pulsed

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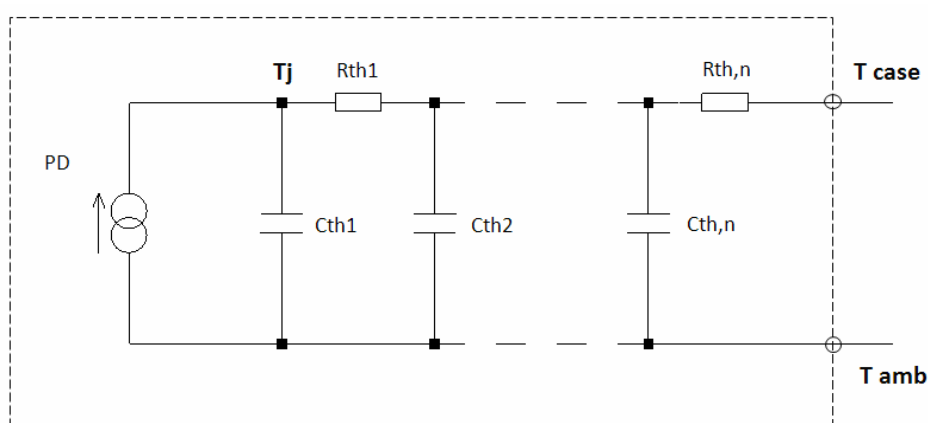
●Body diode electrical characteristics (Source-Drain) ( $T_a = 25^\circ\text{C}$ )

| Parameter                                 | Symbol         | Conditions                                                                | Values |      |      | Unit |
|-------------------------------------------|----------------|---------------------------------------------------------------------------|--------|------|------|------|
|                                           |                |                                                                           | Min.   | Typ. | Max. |      |
| Inverse diode continuous, forward current | $I_S^{*1}$     | $T_c = 25^\circ\text{C}$                                                  | -      | -    | 22   | A    |
| Inverse diode direct current, pulsed      | $I_{SM}^{*2}$  |                                                                           | -      | -    | 55   | A    |
| Forward voltage                           | $V_{SD}^{*3}$  | $V_{GS} = 0\text{V}, I_S = 7\text{A}$                                     | -      | 4.1  | -    | V    |
| Reverse recovery time                     | $t_{rr}^{*3}$  | $I_F = 7\text{A}, V_R = 400\text{V}$<br>$di/dt = 160\text{A}/\mu\text{s}$ | -      | 26   | -    | ns   |
| Reverse recovery charge                   | $Q_{rr}^{*3}$  |                                                                           | -      | 39   | -    | nC   |
| Peak reverse recovery current             | $I_{rrm}^{*3}$ |                                                                           | -      | 3.0  | -    | A    |

### ● Typical Transient Thermal Characteristics

| Symbol    | Value | Unit |
|-----------|-------|------|
| $R_{th1}$ | 96.1m | K/W  |
| $R_{th2}$ | 404m  |      |
| $R_{th3}$ | 196m  |      |

| Symbol    | Value | Unit |
|-----------|-------|------|
| $C_{th1}$ | 1.55m | Ws/K |
| $C_{th2}$ | 5.23m |      |
| $C_{th3}$ | 83.3m |      |



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## ●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

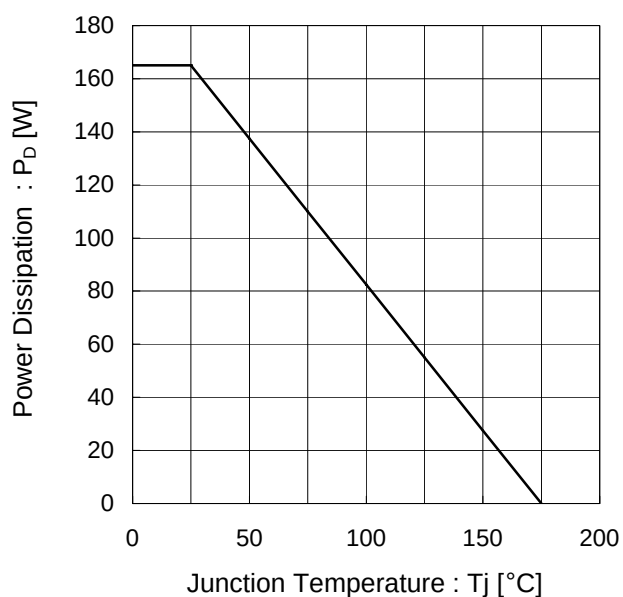


Fig.2 Maximum Safe Operating Area

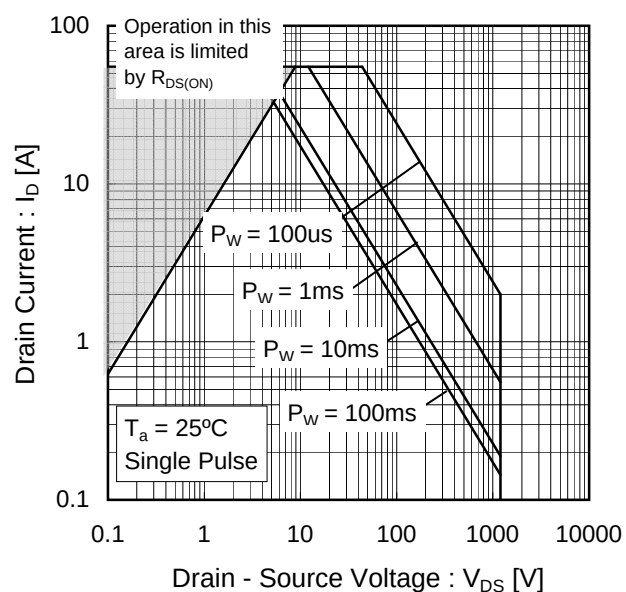
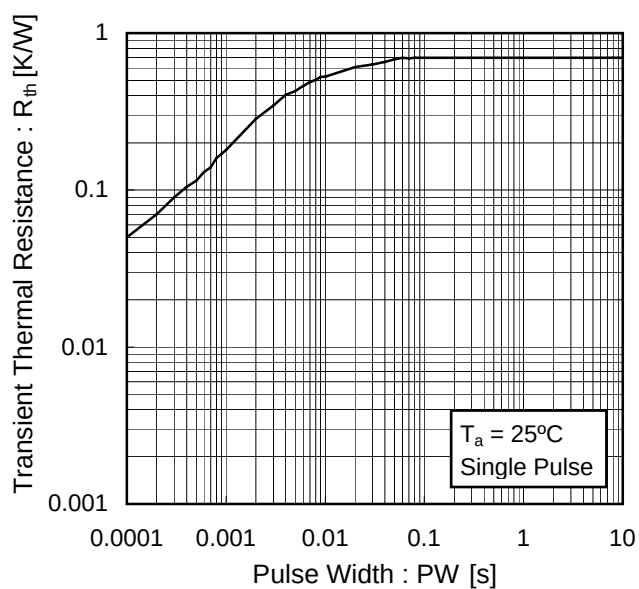


Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



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## ●Electrical characteristic curves

Fig.4 Typical Output Characteristics(I)

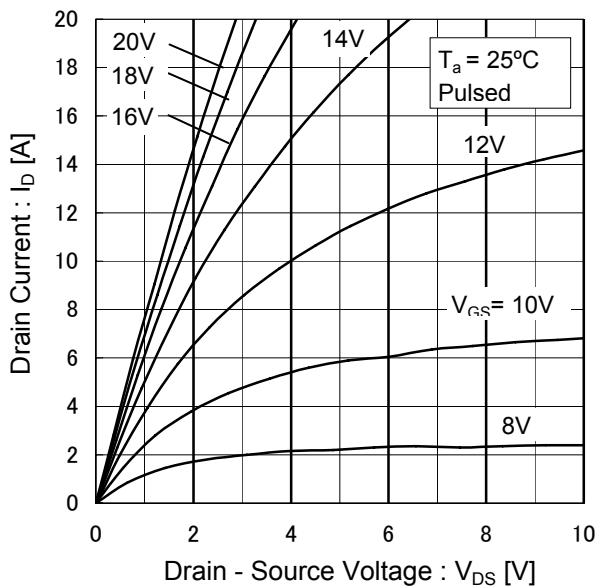
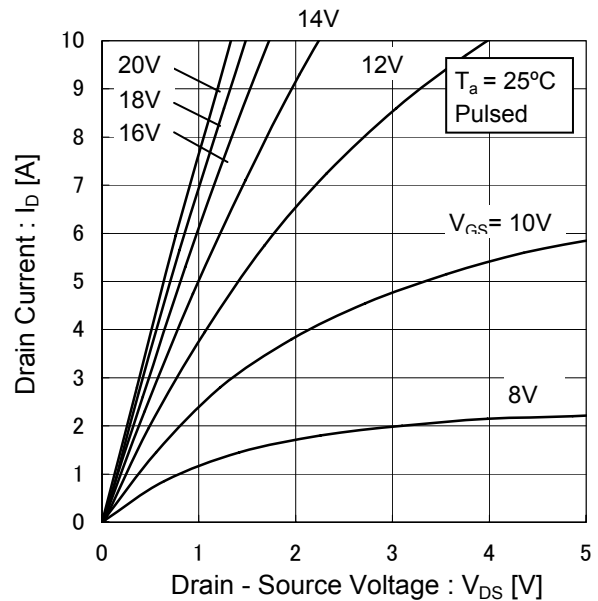
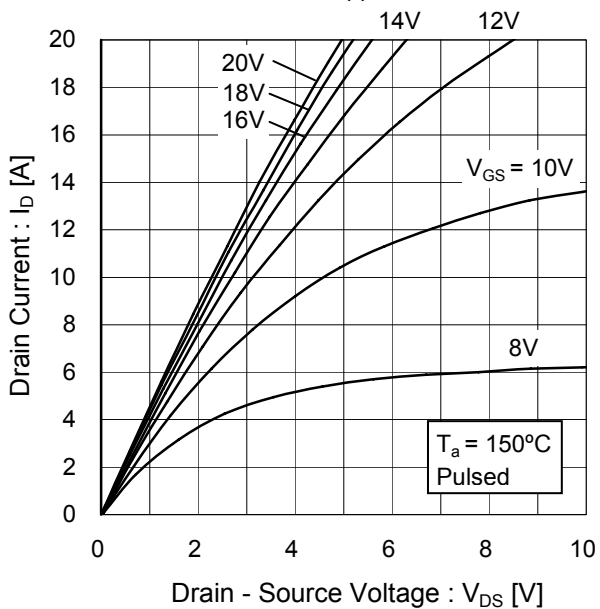
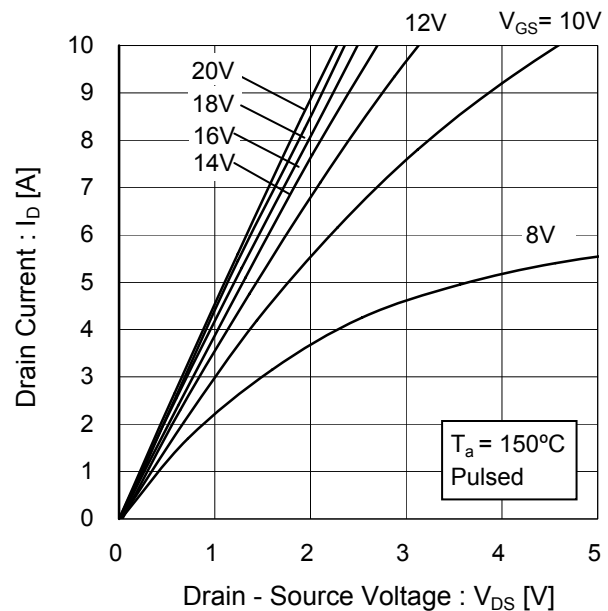


Fig.5 Typical Output Characteristics(II)

Fig.6  $T_j = 150^\circ\text{C}$  Typical Output Characteristics(I)Fig.7  $T_j = 150^\circ\text{C}$  Typical Output Characteristics(II)

## ●Electrical characteristic curves

Fig.8 Typical Transfer Characteristics (I)

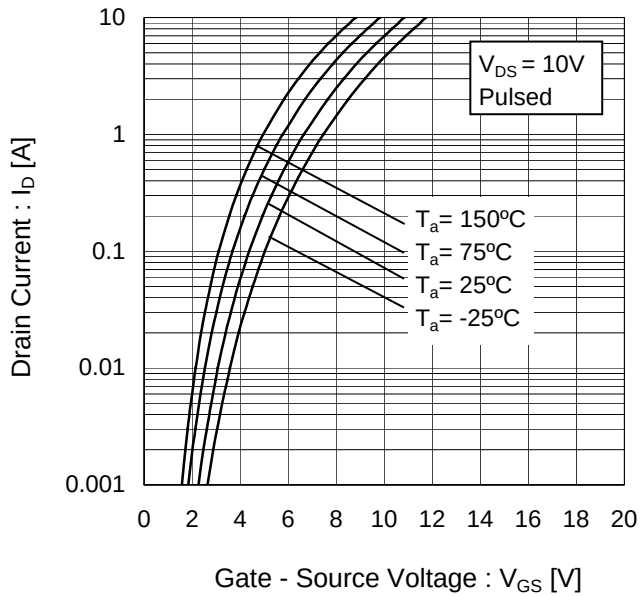


Fig.8 Typical Transfer Characteristics (II)

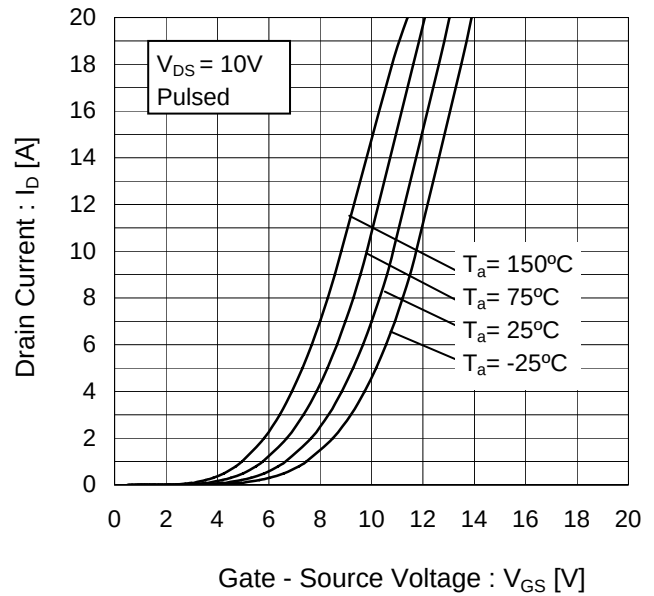


Fig.9 Gate Threshold Voltage vs. Junction Temperature

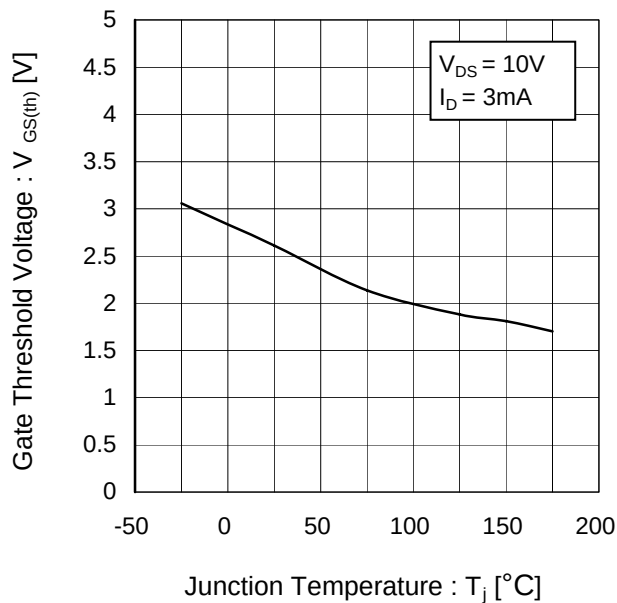
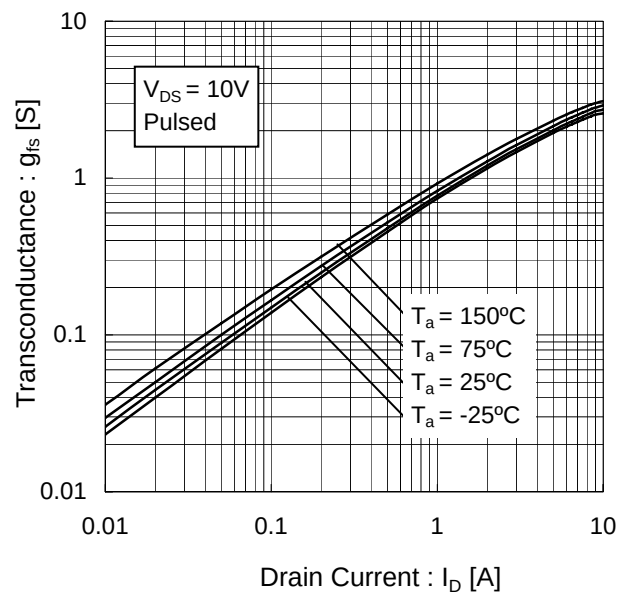


Fig.10 Transconductance vs. Drain Current



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# ●Electrical characteristic curves

Fig.11 Static Drain - Source On - State Resistance vs. Gate - Source Voltage

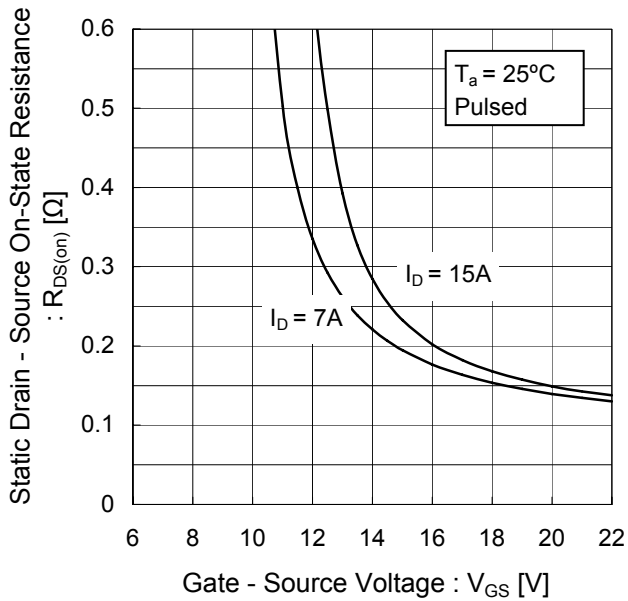


Fig.12 Static Drain - Source On - State Resistance vs. Junction Temperature

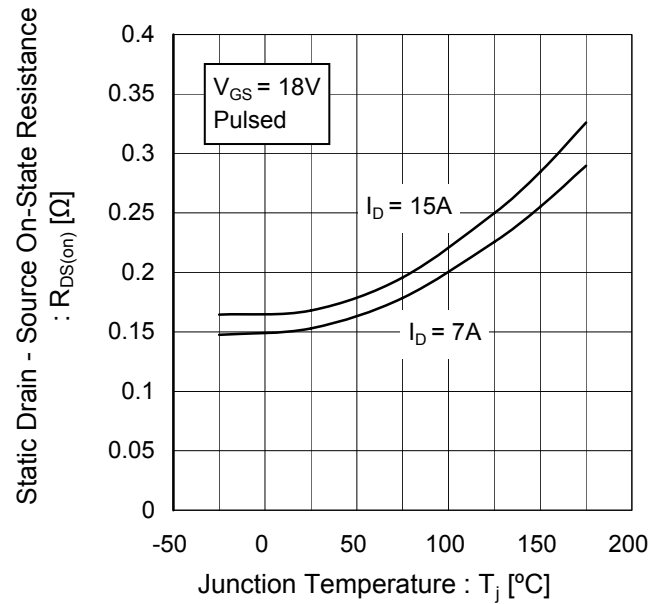
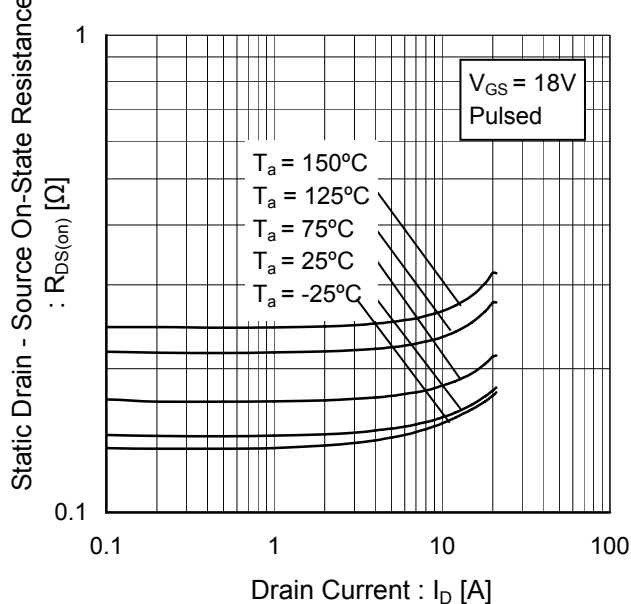


Fig.13 Static Drain - Source On - State Resistance vs. Drain Current





## ●Electrical characteristic curves

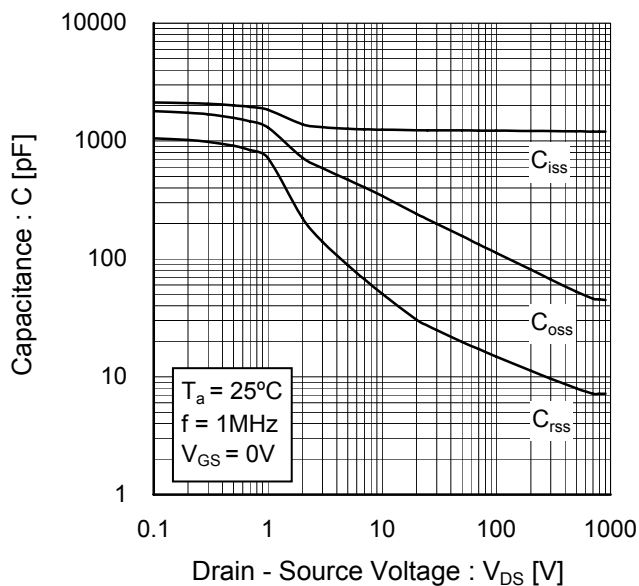
Fig.14 Typical Capacitance  
vs. Drain - Source Voltage

Fig.15 Coss Stored Energy

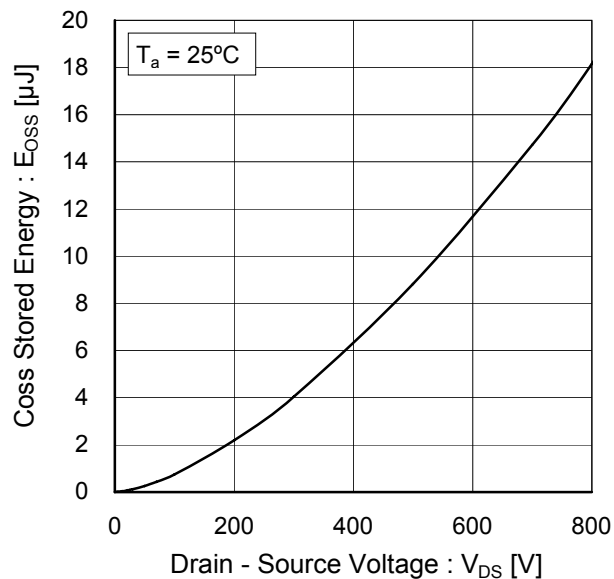


Fig.16 Switching Characteristics

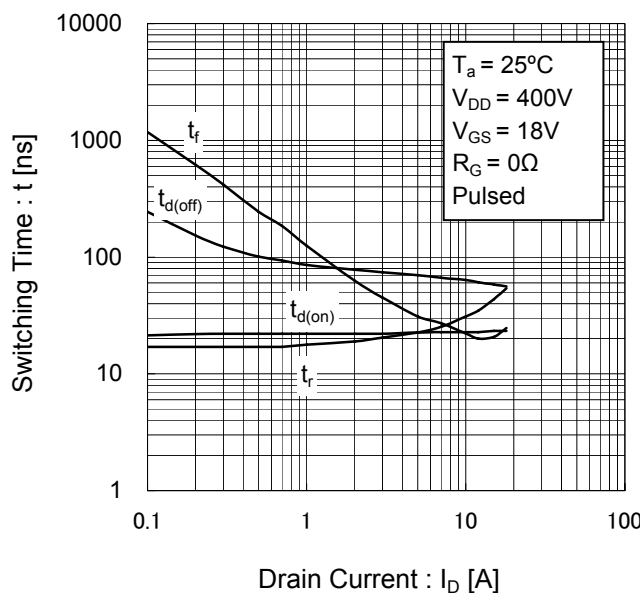
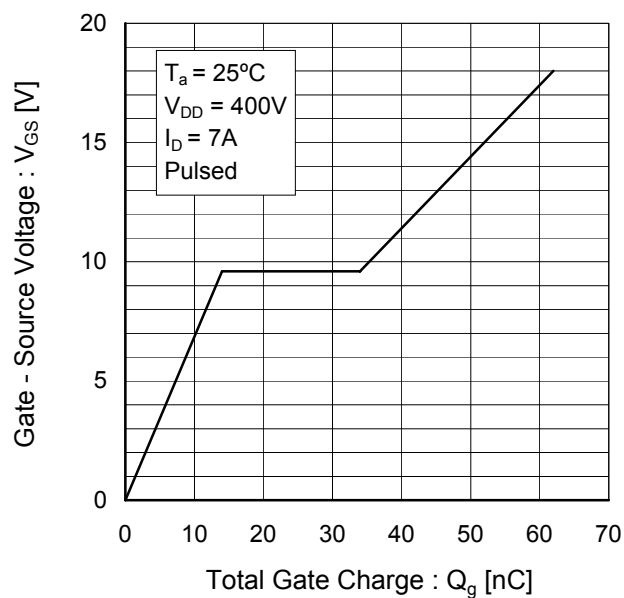
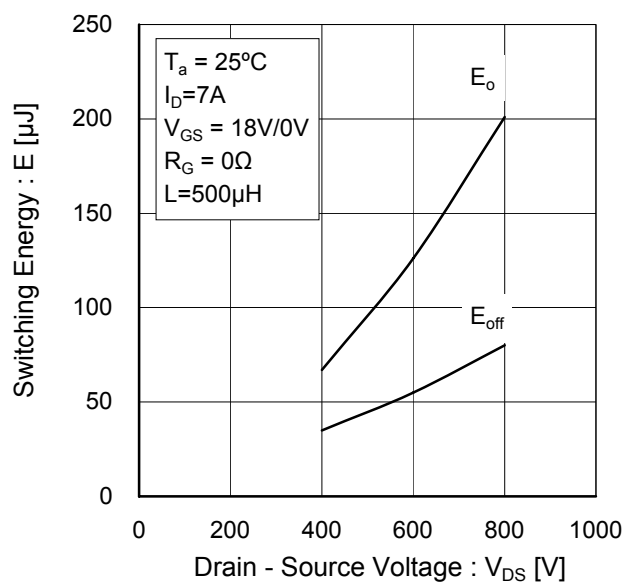
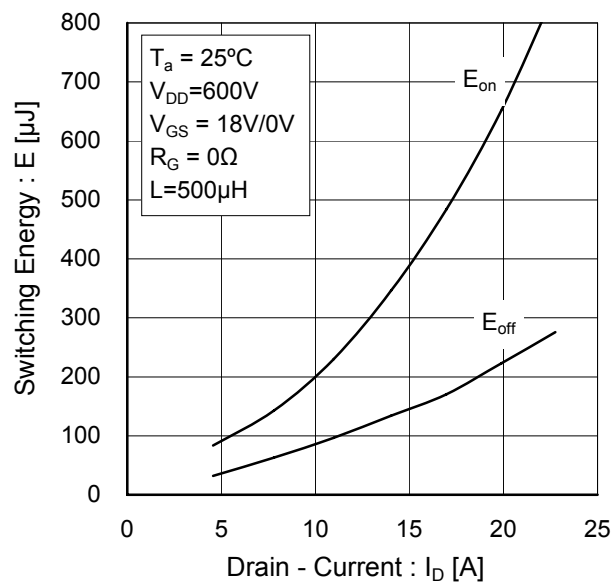
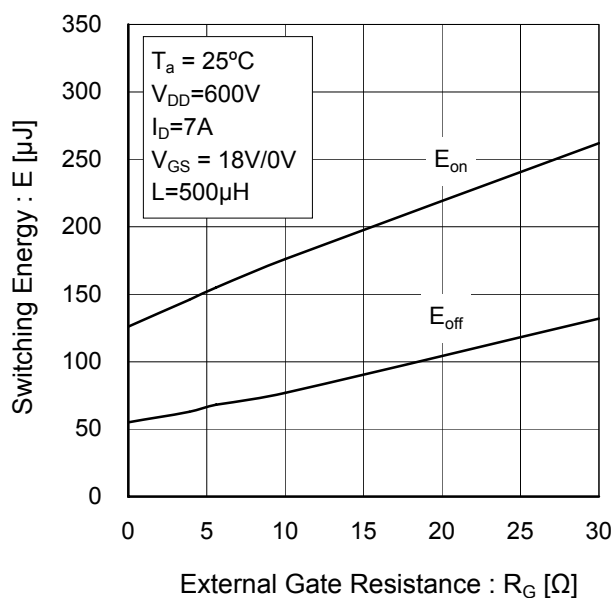


Fig.17 Dynamic Input Characteristics

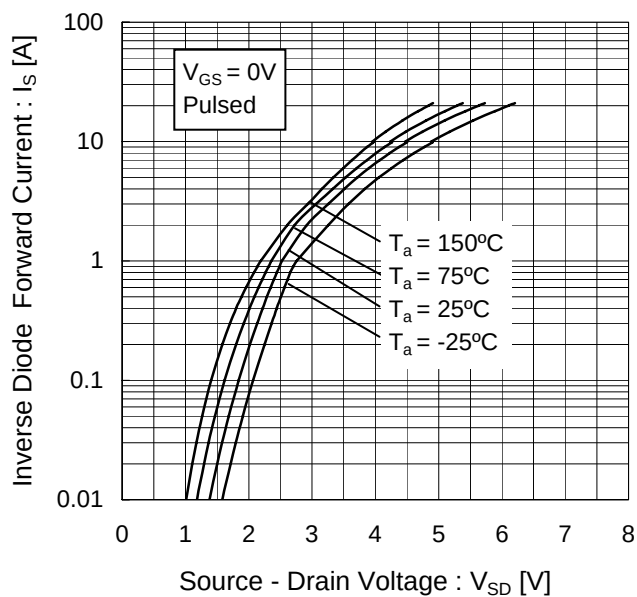
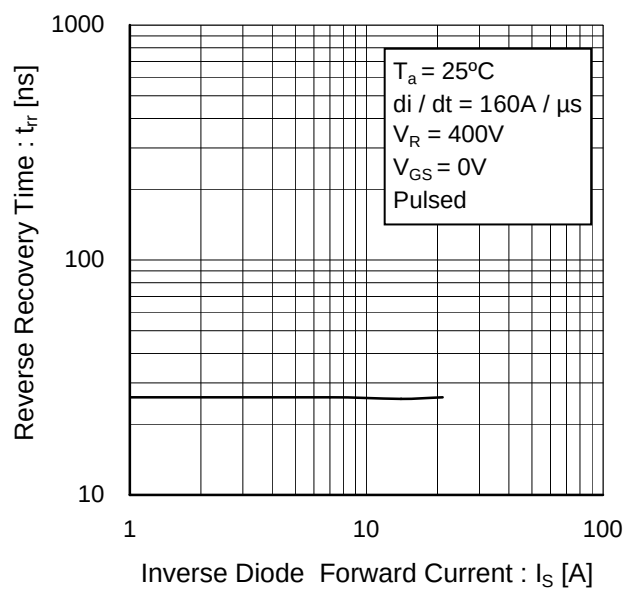


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## ●Electrical characteristic curves

Fig.18 Typical Switching Loss  
vs. Drain - Source VoltageFig.19 Typical Switching Loss  
vs. Drain CurrentFig.20 Typical Switching Loss  
vs. External Gate Resistance

## ●Electrical characteristic curves

Fig.21 Inverse Diode Forward Current  
vs. Source - Drain VoltageFig.22 Reverse Recovery Time  
vs. Inverse Diode Forward Current

## ●Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

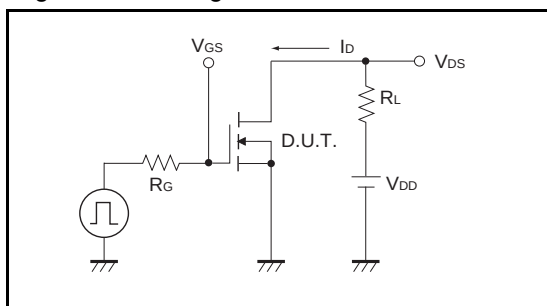


Fig.1-2 Switching Waveforms

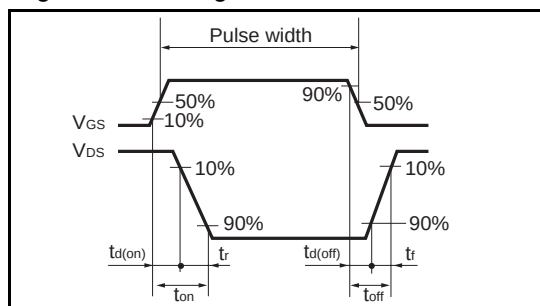


Fig.2-1 Gate Charge Measurement Circuit

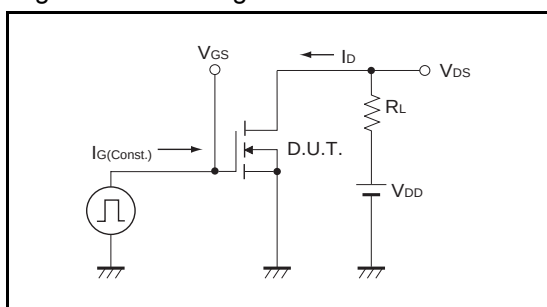


Fig.2-2 Gate Charge Waveform

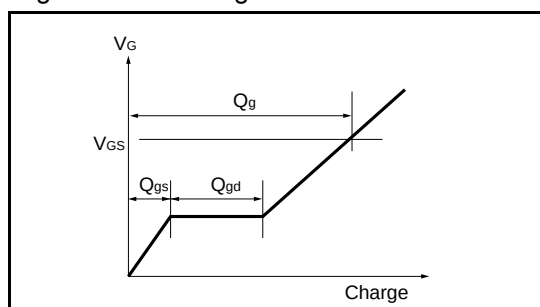


Fig.3-1 Switching Energy Measurement Circuit

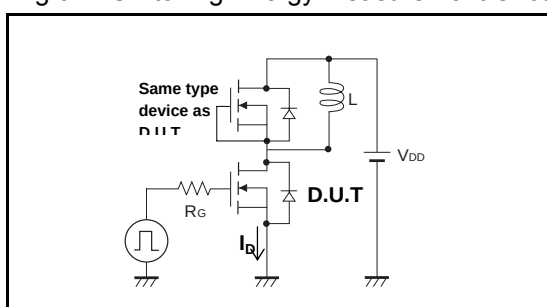


Fig.3-2 Switching Waveforms

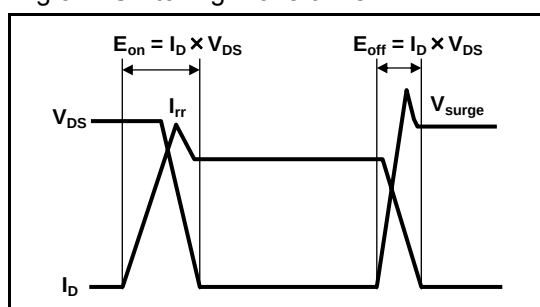


Fig.4-1 Reverse Recovery Time Measurement Circuit

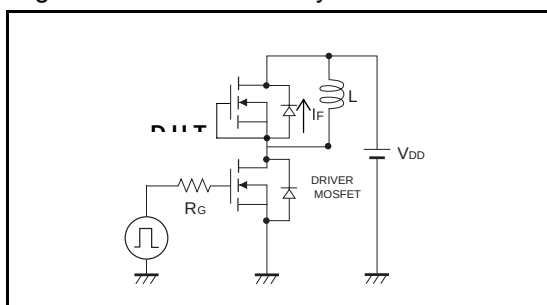
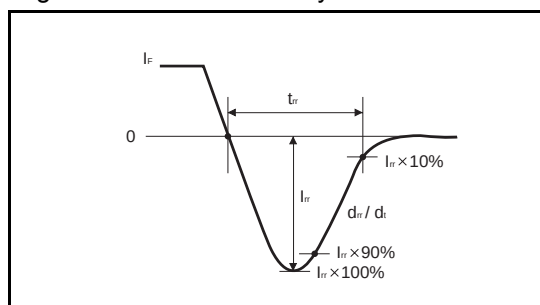


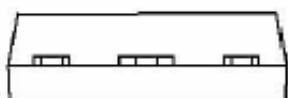
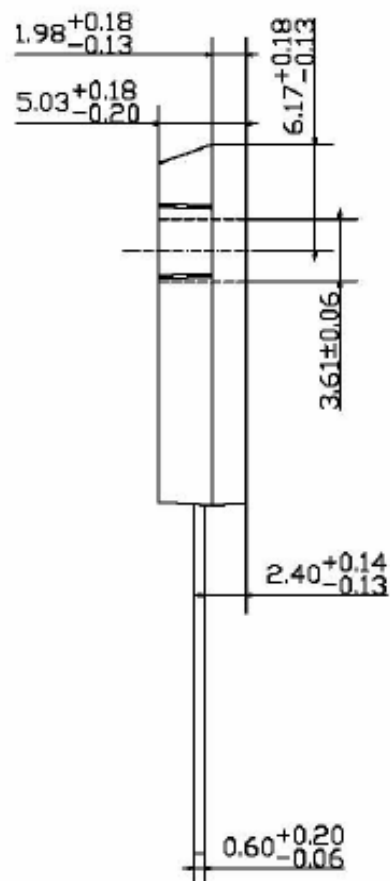
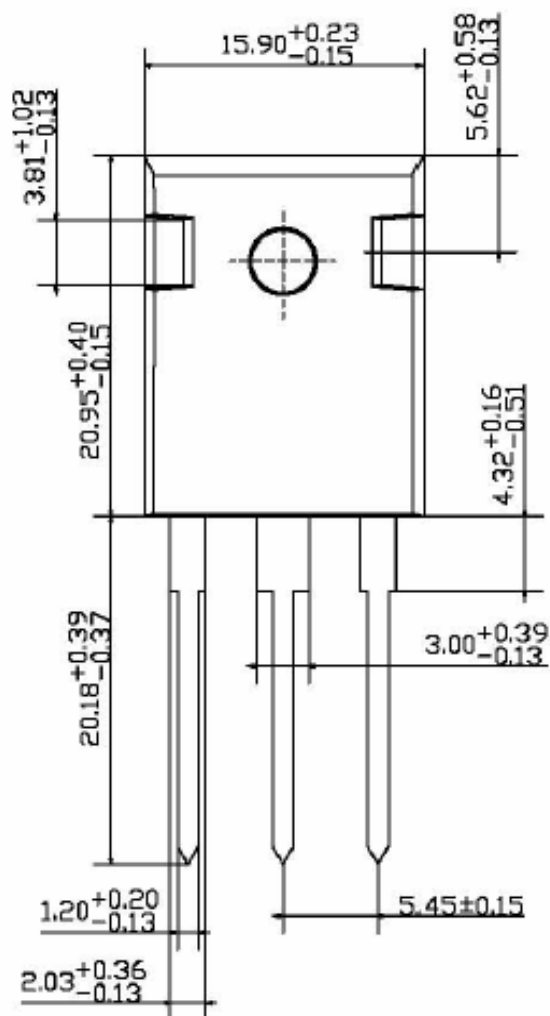
Fig.4-2 Reverse Recovery Waveform



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## ●Dimensions (Unit : mm)

## TO-247



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«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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